

Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- AC input with transistor output
- Operating temperature range - 40°C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1

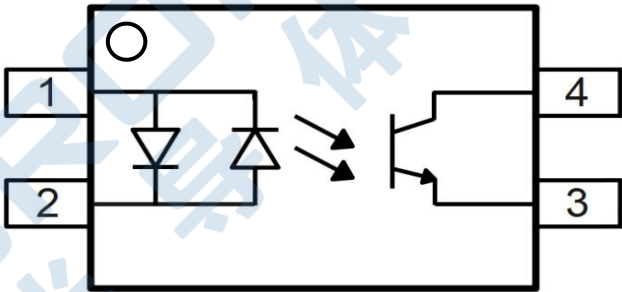
Applications

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

Description

The IS280x series combine two AlGaAs infrared emitting diodes as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SSOP4 package.

With the robust coplanar double mold structure, IS280x series provide the most stable isolation feature.



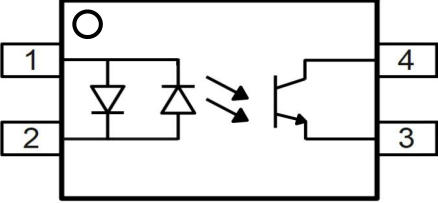
ORDERING INFORMATION

Outline	Part Number	Package	Marking	Packing	Packing Size	Quantity
	IS280A	SSOP4	AHPX /YWW	Reel	13 "	3000
	IS280B					
	IS280GR					

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PIN CONFIGURATION AND FUNCTIONS

	Pin	Name
	1	Anode/ Cathode
	2	Cathode/Anode
	3	Emitter
	4	Collector

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit	Note
INPUT				
Forward Current	I_F	± 60	mA	
Peak Forward Current	I_{FP}	± 1	A	1
Input Power Dissipation	P_i	100	mW	
OUTPUT				
Collector - Emitter Voltage	V_{CEO}	80	V	
Emitter - Collector Voltage	V_{ECO}	6	V	
Collector Current	I_C	50	mA	
Output Power Dissipation	P_O	150	mW	
COMMON				
Total Power Dissipation	P_{tot}	200	mW	
Isolation Voltage	V_{iso}	3750	Vrms	2
Operating Temperature	T_{opr}	-40~110	°C	
Storage Temperature	T_{stg}	-55~125	°C	
Soldering Temperature	T_{sol}	260	°C	

Note 1. 100 μ s pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

ELECTRICAL OPTICAL CHARACTERISTICS(Ta=25°C)

Parameter		Symbol	Min	Typ.	Max.	Unit	Test Condition	Note
INPUT								
Forward Voltage		V _F	-	-	1.4	V	I _F =10mA	
Input Capacitance		C _{in}	-	10	-	pF	V=0, f=1kHz	
OUTPUT								
Collector Dark Current		I _{CEO}	-	-	100	nA	V _{CE} =20V, I _F =0	
Collector-Emitter Breakdown Voltage		BV _{CEO}	80	-	-	V	I _C =0.1mA, I _F =0	
Emitter-Collector Breakdown Voltage		BV _{ECO}	6	-	-	V	I _E =0.1mA, I _F =0	
TRANSFER CHARACTERISTICS								
Current Transfer Ratio	280GR	CTR	50		300	%	I _F =±1mA, V _{CE} =5V	
	280A		50	-	150			
	280B		80	-	300			
CTR Symmetry			0.7	-	1.3		I _F =±1mA, V _{CE} =5V	
Collector-Emitter Saturation Voltage		V _{CE(sat)}	-	0.07	0.2	V	I _F =20mA, I _C =1mA	
Isolation Resistance		R _{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C _{IO}	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)		t _r	-	7	18	μs	V _{CE} =2V, I _C =2mA R _L =100Ω	3
Response Time (Fall)		t _f	-	9	18	μs		3

Note 3. Fig.12&13

Note 4. Fig.14

CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Ambient Temperature

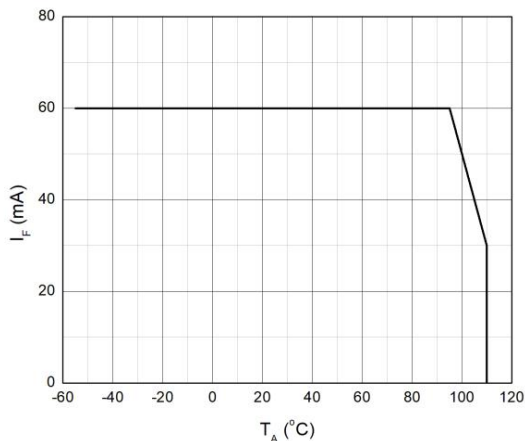


Fig.2 Collector Power Dissipation vs. Ambient Temperature

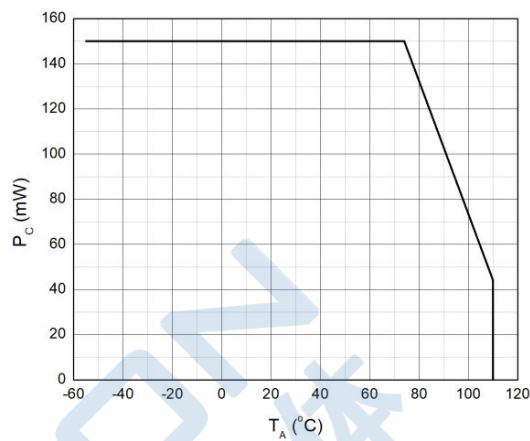


Fig.3 Forward Current vs. Forward Voltage

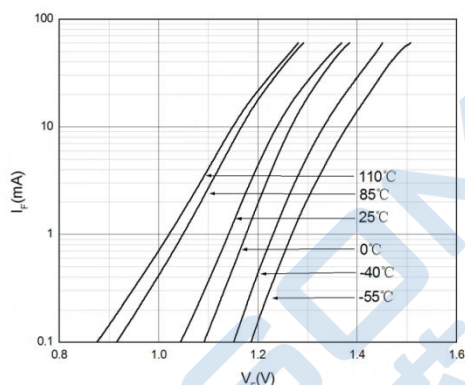


Fig.4 Collector Dark Current vs. Ambient Temperature

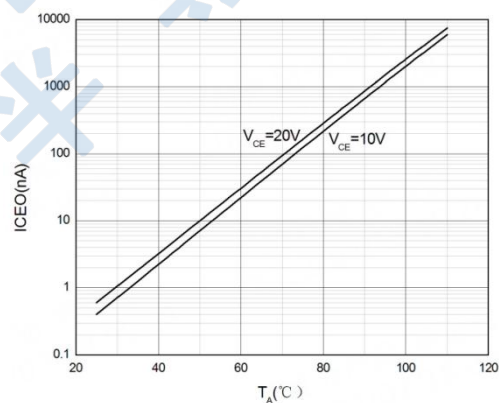


Fig.5 Collector Current vs. Collector-emitter Voltage

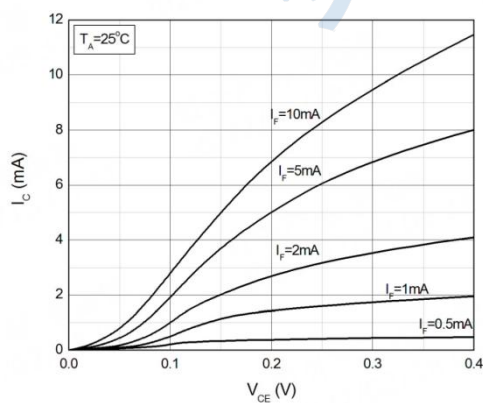


Fig.6 Collector Current vs. Collector-emitter Voltage

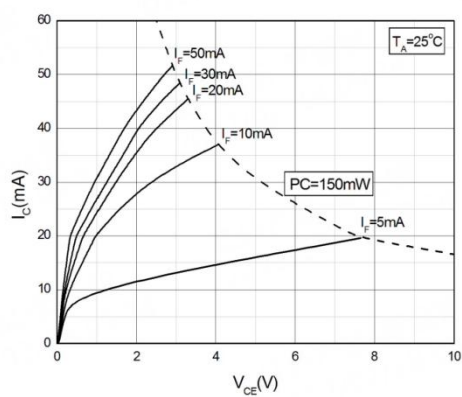


Fig.7 Normalized Current Transfer Ratio vs. Forward Current

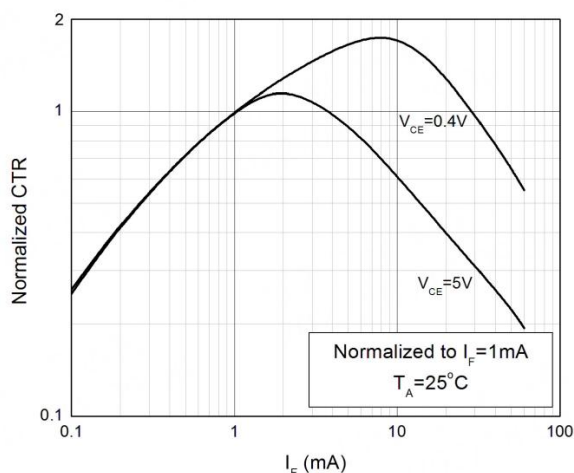


Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature

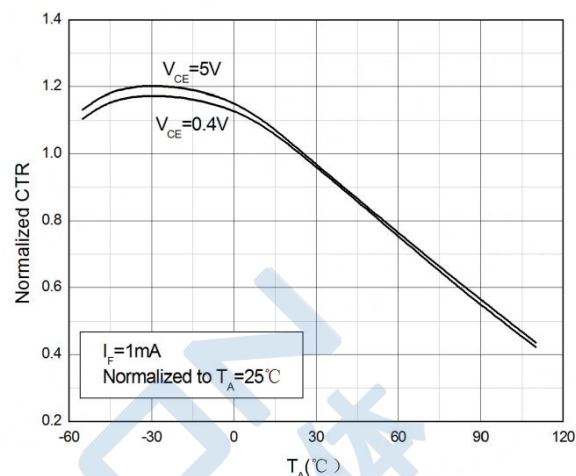


Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature

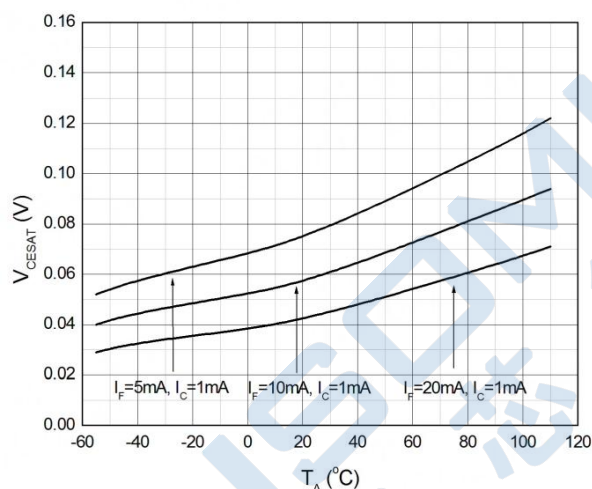


Fig.10 Switching Time vs. Load Resistance

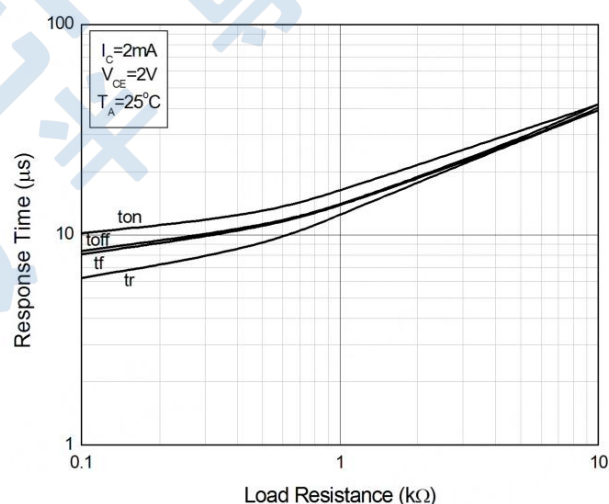
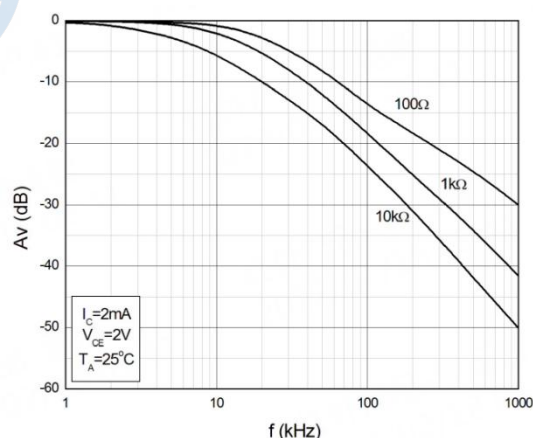


Fig.11 Frequency Response



TEST CIRCUITS

Fig.12 Test Circuits of Response Time

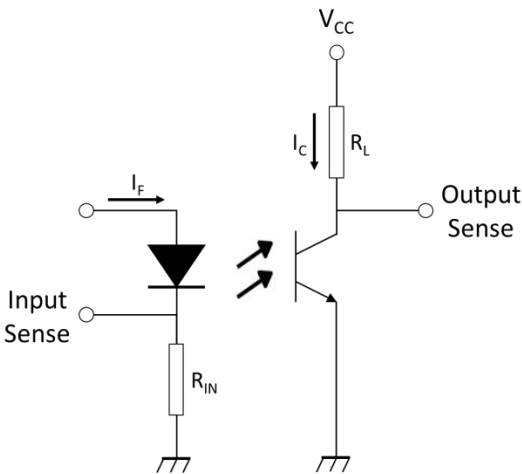


Fig.13 Curves of Response Time

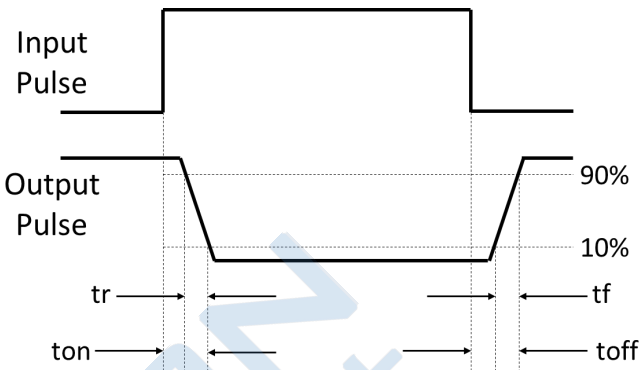
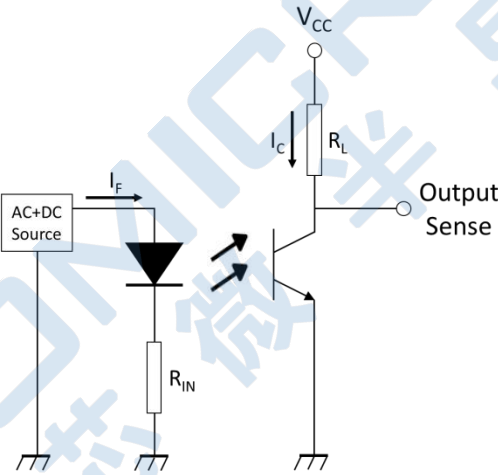
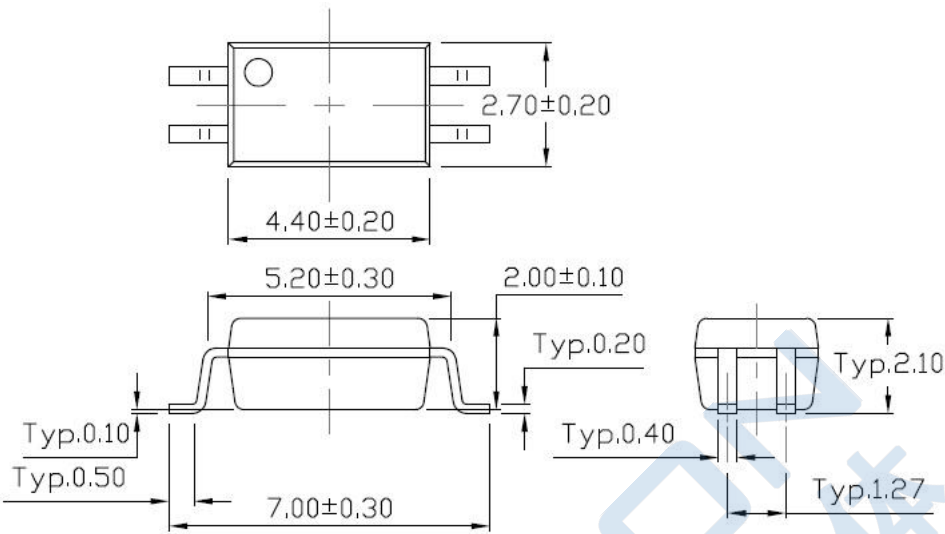


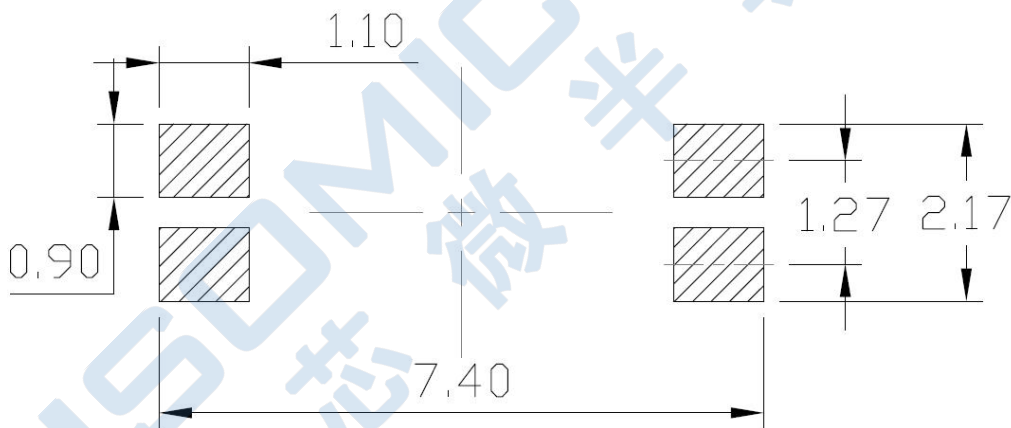
Fig.14 Test Circuits of Frequency Response



PACKAGE DIMENSIONS



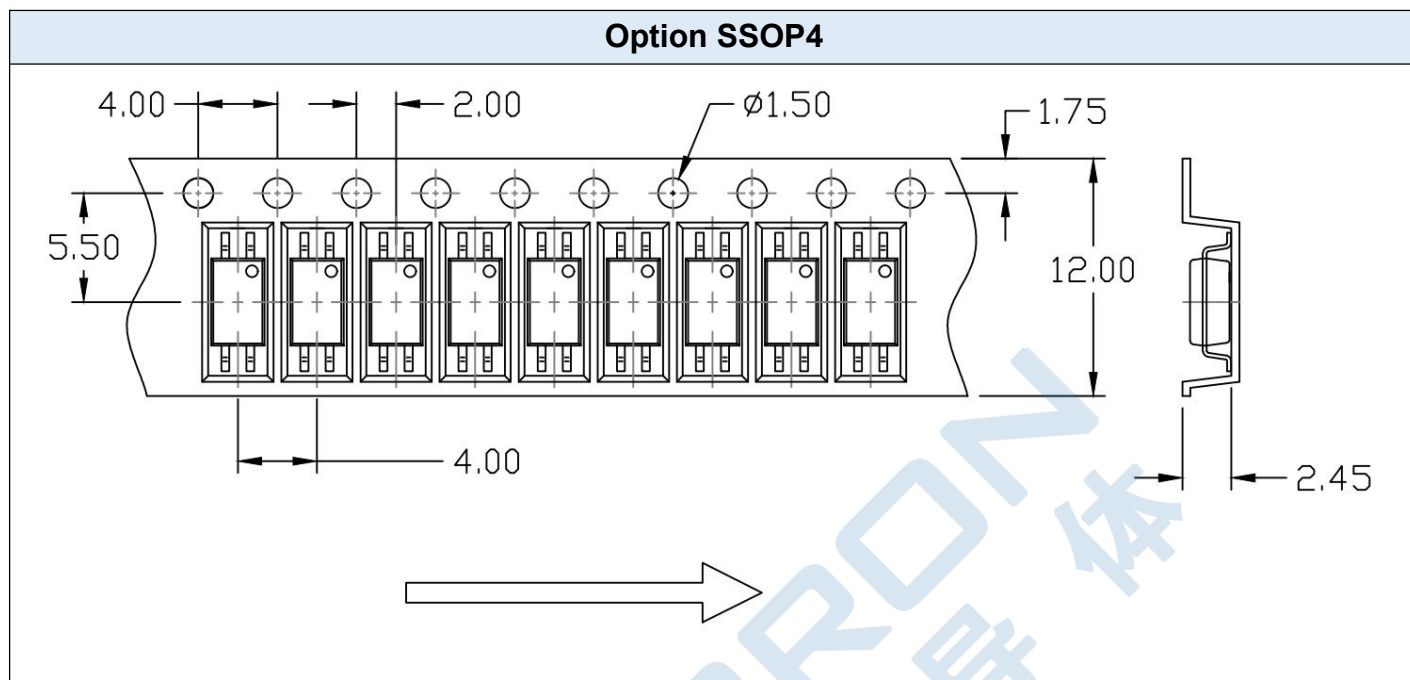
Recommended Solder Mask



- Dimensions in mm unless otherwise stated

CARRIER TAPE SPECIFICATIONS

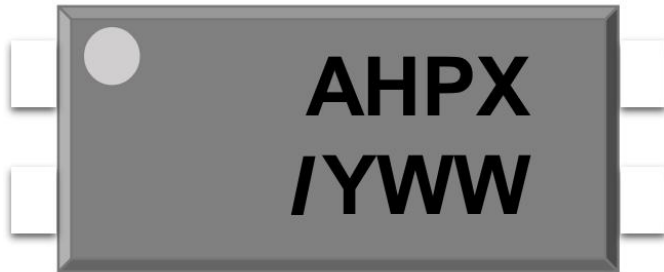
Option SSOP4



- **Dimensions in mm unless otherwise stated**

ORDERING AND MARKING INFORMATION

Marking Information



AHP : Part Number
X : CTR Grade(1:A/GR, 2:B)
/ : ISOMICRON
Y : Fiscal Year (M:2022,N:2023...)
WW : Work Week

Order Code

IS **280** **X - X E**

Company Abbr. ← IS

Part Number ← 280

CTR Rank: ← X
A/B/GR

Halogen Free:
E/None: Halogen-free, Lead-free
Z: Halogen, Lead-free

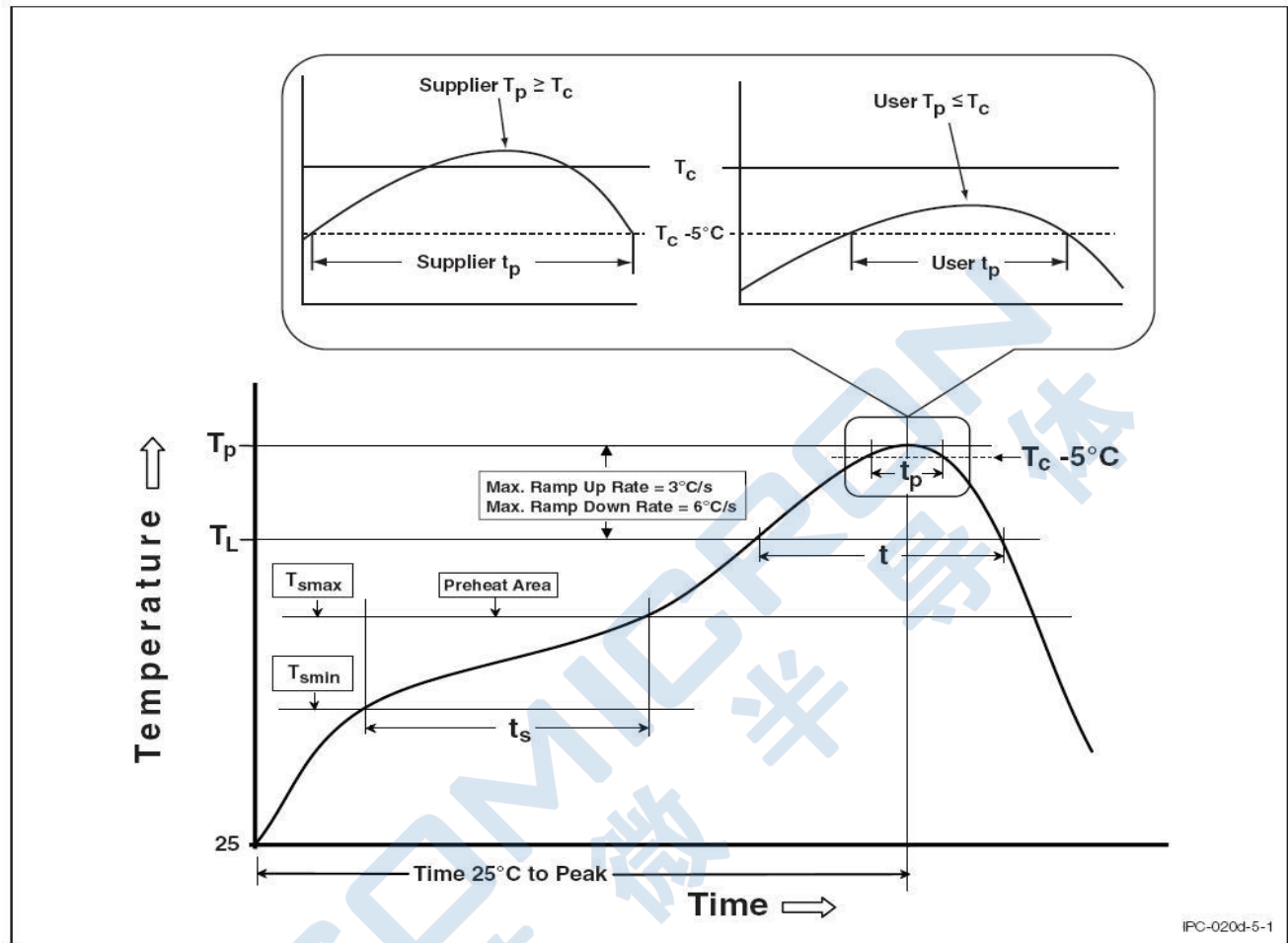
Performance:
N: Enhanced
None: Normal

Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity – Outer box
SSOP4	3000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 30k Units

REFLOW INFORMATION

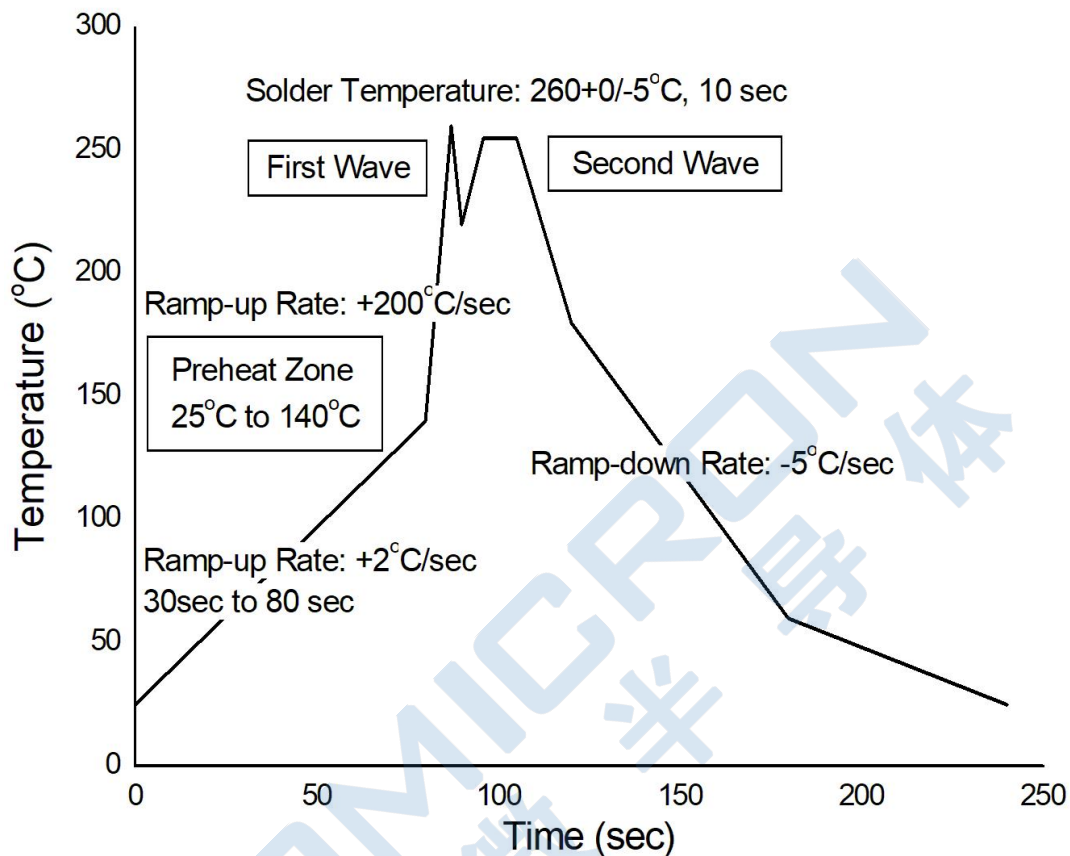
Reflow Profile



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmmin)	100	150°C
Temperature Max. (Tsmmax)	150	200°C
Time (ts) from (Tsmmin to Tsmmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

TEMPERATURE PROFILE OF SOLDERING

Wave Soldering (JESD22-A111 COMPLIANT)



Hand Soldering By Soldering Iron

Soldering Temperature	380+0/-5°C
Soldering Time	3 sec max.

- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.

DISCLAIMER

- ISOMICRON is continually improving the quality, reliability, function and design. ISOMICRON reserves the right to make changes without further notices.
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- Please contact ISOMICRON sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
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- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.